

PMP10974 REV A Bill of Materials

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
!PCB900	1		PMP10974	Any	Printed Circuit Board	
C900	1	2200pF	DE6E3KJ222MN3A	MuRata	CAP, CERM, 2200 pF, 300 V, +/- 20%, E, TH, 2- Leads, Body 9x7mm, Pin Spacing 7.5mm	TH, 2- Leads, Body 9x7mm, Pin Spacing 7.5mm
C901	1	100uF	UPT2G101MHD6	Panasonic	CAP ALUM 100UF 400V 20% RADIAL	18x25
C902	1	100uF	GRM32ER60J107ME20L	MuRata	CAP, CERM, 100 μF, 6.3 V, +/- 20%, X5R, 1210	1210
C903	1	0.33uF	890324024003	Wurth	CAP FILM 0.33UF 10% 275V RADIAL	TH, 2-Leads, Body 15x8mm, Pin Spacing 12.5mm
C904, C905, C906	3	680uF	PLE0J681MDO1	Nichicon	CAP ALUM 680UF 6.3V 20% RADIAL	10x12.5mm
C907	1	470uF	6.3YXJ470M6.3X11	Rubycon	CAP ALUM 470UF 6.3V 20% RADIAL	6.3x5.5mm
C908	1	1uF	C0603C105K4PACTU	Kemet	CAP, CERM, 1 µF, 16 V, +/- 10%, X5R, 0603	0603
C909	1	0.1uF	08053C104KAT2A	AVX	CAP, CERM, 0.1uF, 25V, +/-10%, X7R, 0805	0805
C910	1	100pF	C1608C0G2A101J	TDK	CAP, CERM, 100pF, 100V, +/-5%, C0G/NP0, 0603	0603
C911	1	2.2uF	GRM316R61E225KA12D	MuRata	CAP, CERM, 2.2 µF, 25 V, +/- 10%, X5R, 1206	1206
C912	1	0.1uF	06035C104KAT2A	AVX	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	0603
C913, C915, C919, C920, C923, C925	6	1uF	GRM155R61A105KE15D	MuRata	CAP, CERM, 1uF, 10V, +/-10%, X5R, 0402	0402
C914, C917, C924, C926	4	47uF	GRM31CR61A476KE15L	MuRata	CAP, CERM, 47uF, 10V, +/-10%, X5R, 1206	1206
C916, C918, C921, C922	4	0.1uF	C1005X5R0J104K	ТДК	CAP, CERM, 0.1uF, 6.3V, +/-10%, X5R, 0402	0402
D900, D904	2	600V	MURS360T3G	ON Semiconductor	Diode, Ultrafast, 600 V, 3 A, SMC	SMC
D901	1	800V	GBU4K-E3/45	Vishay-Semiconductor	Diode, Switching-Bridge, 800V, 4A, TH	GBU
D902	1	30V	BAT54-7-F	Diodes Inc.	Diode, Schottky, 30 V, 0.2 A, SOT-23	SOT-23
D903	1	100V	BAS316,115	NXP Semiconductor	Diode, Ultrafast, 100 V, 0.25 A, SOD-323	SOD-323
D905	1	5.1V	MMSZ5231B-7-F	Diodes Inc.	Diode, Zener, 5.1 V, 500 mW, SOD-123	SOD-123
D906	1	200V	ES1D-13-F	Diodes Inc.	Diode, Ultrafast, 200V, 1A, SMA	SMA
D907, D908	2	30V	BAT54HT1G	ON Semiconductor	Diode, Schottky, 30V, 0.2A, SOD-323	SOD-323
D909	1	16V	MMSZ5246BS-7-F	Diodes Inc.	Diode, Zener, 16 V, 200 mW, SOD-323	SOD-323
F900	1		RST 2-BULK	Bel Fuse	FUSE BOARD MOUNT 2A 250VAC RAD	8.35x7.7x4mm
J900, J901, J902, J903	4		0894858000	Molex	Connector, Shielded USB Type A, Gold, R/A, TH	Connector, Shielded USB Type A, R/A, TH
J904	1		770W-X2/10	Qualtek Electronics Corpora	atic AC Receptacle, 2.5A, R/A, TH	AC, Reception 14.5x15x22 mm
J905	1		923345-03-C	3M	Jumper Wire, 300mil spacing, Orange, pkg of 200	300 mil Jumper Wire
L900	1	4mH	744821240	Wurth Elektronik eiSos	Coupled inductor, 4 mH, 1.5 A, 0.14 ohm, +/- 30%, TH	15 x 18 x 7.5mm
Q900, Q903	2	550V	IPP50R380CE	Infineon Technologies	MOSFET N CH 500V 9.9A PGTO220	TO-220AB
Q901	1	60V	2N7002-7-F	Diodes Inc.	MOSFET, N-CH, 60 V, 0.17 A, SOT-23	SOT-23
Q902	1	40V	CSD18509Q5B	Texas Instruments	MOSFET, N-CH, 40 V, 38 A, SON 5x6mm	SON 5x6mm
Q904	1	40 V	MMBT2222A	Fairchild Semiconductor	Transistor, NPN, 40 V, 0.15 A, SOT-23	SOT-23
Q905	1	60 V	MMBT2907A	Fairchild Semiconductor	Transistor, PNP, 60 V, 0.8 A, SOT-23	SOT-23
R900	1	3.0	CRCW06033R00JNEA	Vishay-Dale	RES, 3.0, 5%, 0.1 W, 0603	0603
R901	1	100k	CRCW0603100KJNEA	Vishay-Dale	RES, 100 k, 5%, 0.1 W, 0603	0603
R902	1	1.0k	CRCW06031K00JNEA	Vishay-Dale	RES, 1.0 k, 5%, 0.1 W, 0603	0603
R903	1	DNP	CRCW08050000Z0EA	Vishay-Dale	RES, 0 ohm, 5%, 0.125W, 0805	0805

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
R904	1	191k	CRCW0603191KFKEA	Vishay-Dale	RES, 191 k, 1%, 0.1 W, 0603	0603
R905	1	150k	CRCW0603150KFKEA	Vishay-Dale	RES, 150 k, 1%, 0.1 W, 0603	0603
R906	1	0	CRCW06030000Z0EA	Vishay-Dale	RES, 0, 5%, 0.1 W, 0603	0603
R907	1	10.0k	CRCW060310K0FKEA	Vishay-Dale	RES, 10.0 k, 1%, 0.1 W, 0603	0603
R908	1	49.9k	CRCW060349K9FKEA	Vishay-Dale	RES, 49.9 k, 1%, 0.1 W, 0603	0603
R909	1	100	CRCW0603100RFKEA	Vishay-Dale	RES, 100, 1%, 0.1 W, 0603	0603
R910	1	60.4k	CRCW060360K4FKEA	Vishay-Dale	RES, 60.4 k, 1%, 0.1 W, 0603	0603
R911	1	90.9k	CRCW060390K9FKEA	Vishay-Dale	RES, 90.9 k, 1%, 0.1 W, 0603	0603
R912	1	100k	CRCW0805100KJNEA	Vishay-Dale	RES, 100k ohm, 5%, 0.125W, 0805	0805
R913	1	976	CRCW0603976RFKEA	Vishay-Dale	RES, 976, 1%, 0.1 W, 0603	0603
R914, R915	2	0.4	CSRN2010FKR400	Stackpole Electronics Inc	RES, 0.4, 1%, 1 W, 2010	2010
R916	1	20.5k	CRCW060320K5FKEA	Vishay-Dale	RES, 20.5 k, 1%, 0.1 W, 0603	0603
R918	1	36.5k	CRCW060336K5FKEA	Vishay-Dale	RES, 36.5 k, 1%, 0.1 W, 0603	0603
R926	1	44.2k	CRCW040244K2FKED	Vishay-Dale	RES, 44.2 k, 1%, 0.063 W, 0402	0402
R927, R928,	4	0	CRCW12060000Z0EA	Vishay-Dale	RES, 0, 5%, 0.25 W, 1206	1206
R929, R930						
T900	1	750 uH	760301302	Wurth Elektronik eiSos	Transformer, 750 uH, TH	10.5x10.5mm
T901	1	260 µH	RLTI-1139	Renco Electronics	Transformer, 90 uH, TH	1200x1200mil
U900	1	•	UCC24636DBV	Texas Instruments	SYNCRONOUS RECTIFIER CONTROLLER WITH LOW POWER	DBV0006A
					STANDBY, DBV0006A	
U901	1		UCC28730D	Texas Instruments	Constant-Voltage Constant-Current Flyback Controller With PSR and	D0007A
					Wake-Up Monitoring, D0007A	
U904, U905,	4		TPD2E001DRLR	Texas Instruments	Low-Capacitance + / - 15 kV ESD-Protection Array for High-Speed Data	DRL0005A
U908, U909					Interfaces, 2 Channels, -40 to +85 degC, 5-pin SOT (DRL), Green (RoHS	
					& no Sb/Br)	
U906, U907	2		TPS2513DBV	Texas Instruments	DUAL CHÁNNEL AUTO DETECT USB CHARGING CONTROLLER,	DBV0006A
					DBV0006A	
R917	0	47.5k	CRCW060347K5FKEA	Vishay-Dale	RES, 47.5 k, 1%, 0.1 W, 0603	0603
R919, R920,	0	10.0k	CRCW040210K0FKED	Vishay-Dale	RES, 10.0k ohm, 1%, 0.063W, 0402	0402
R923, R924						
R921, R922, R925	0	44.2k	CRCW040244K2FKED	Vishay-Dale	RES, 44.2 k, 1%, 0.063 W, 0402	0402
, ,						
U902, U903,	0		TPS2559DRC	Texas Instruments	Precision Adjustable Current-Limited Power-Distribution Switch,	DRC0010A
U910, U911					DRC0010A	

IMPORTANT NOTICE FOR TI REFERENCE DESIGNS

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers ("Buyers") who are developing systems that incorporate TI semiconductor products (also referred to herein as "components"). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer's systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. **TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design.** TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER'S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer's safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have **not** been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated